## NLSV4T244E

## 4-Bit Dual-Supply Non-Inverting Level Translator

The NLSV4T244E is a 4-bit configurable dual-supply voltage level translator. The input $A_{n}$ and output $B_{n}$ ports are designed to track two different power supply rails, $\mathrm{V}_{\mathrm{CCA}}$ and $\mathrm{V}_{\mathrm{CCB}}$ respectively. Both supply rails are configurable from 0.9 V to 4.5 V allowing universal low-voltage translation from the input $\mathrm{A}_{\mathrm{n}}$ to the output $\mathrm{B}_{\mathrm{n}}$ port.

## Features

- Wide $\mathrm{V}_{\mathrm{CCA}}$ and $\mathrm{V}_{\mathrm{CCB}}$ Operating Range: 0.9 V to 4.5 V
- High-Speed w/ Balanced Propagation Delay
- Inputs and Outputs have OVT Protection to 4.5 V
- Non-preferential $\mathrm{V}_{\mathrm{CCA}}$ and $\mathrm{V}_{\mathrm{CCB}}$ Sequencing
- Outputs at 3-State until Active $\mathrm{V}_{\mathrm{CC}}$ is Reached
- Power-Off Protection
- Outputs Switch to 3-State with $\mathrm{V}_{\mathrm{CCB}}$ at GND
- Data Rate $>200 \mathrm{Mbps} @ \mathrm{~V}_{\mathrm{CCA}}=1.8 \mathrm{~V}, \mathrm{~V}_{\mathrm{CCB}}=3.3 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=2 \mathrm{k} \Omega$, $\mathrm{C}_{\mathrm{L}}=15 \mathrm{pF}$
- Ultra-Small Packaging: $1.7 \mathrm{~mm} \times 2.0 \mathrm{~mm}$ UQFN12
- These are $\mathrm{Pb}-$ Free Devices


## Typical Applications

- Mobile Phones, PDAs, Other Portable Devices


## Important Information

- ESD Protection for All Pins:

HBM (Human Body Model) > 2000 V
MM (Machine Model) $>400 \mathrm{~V}$

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MARKING DIAGRAMS


AF = Specific Device Code
M = Date Code

- = Pb-Free Package
(Note: Microdot may be in either location)


14 ABABAB
SV4T
244E ALYW. 1 atyeyer

| A | $=$ | Assembly Location |
| :--- | :--- | :--- |
| L, WL | $=$ | Wafer Lot |
| Y, YY | $=$ | Year |
| W, WW | $=$ | Work Week |

G or • = Pb-Free Package
(Note: Microdot may be in either location)

ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :---: | :---: | :---: |
| NLSV4T244EMUTAG | UQFN12 <br> (Pb-Free) $)$ |  <br> Reel |
| NLSV4T244EDR2G | SO-14 <br> (Pb-Free) |  <br> Reel |
| NLSV4T244EDTR2G | TSSOP14 <br> (Pb-Free) |  <br> Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NLSV4T244E


Figure 1. Pin Assignments


Figure 2. Logic Diagram

PIN ASSIGNMENT

| PIN | FUNCTION |
| :--- | :--- |
| $V_{\text {CCA }}$ | Input Port DC Power Supply |
| $V_{\text {CCB }}$ | Output Port DC Power Supply |
| GND | Ground |
| $A_{n}$ | Input Port |
| $B_{n}$ | Output Port |
| OE | Output Enable |

TRUTH TABLE

| Inputs |  | Outputs |
| :---: | :---: | :---: |
| OE | $\mathrm{A}_{\mathrm{n}}$ | $\mathrm{B}_{\mathrm{n}}$ |
| L | L | L |
| L | H | H |
| H | X | $3-$ State |

MAXIMUM RATINGS

| Symbol | Rating | Condition | Value | Unit |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CCA }}, \mathrm{V}_{\text {CCB }}$ | DC Supply Voltage |  | -0.5 to +5.5 | V |
| $V_{1}$ | DC Input Voltage $\quad A_{n}$ |  | -0.5 to +5.5 | V |
| $\mathrm{V}_{\mathrm{C}}$ | Control Input $\overline{\mathrm{OE}}$ |  | -0.5 to +5.5 | V |
| $\mathrm{V}_{\mathrm{O}}$ | DC Output Voltage $\quad$ (Power Down) $\mathrm{B}_{\mathrm{n}}$ | $\mathrm{V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}}=0$ | -0.5 to +5.5 | V |
|  | (Active Mode) $\mathrm{B}_{\mathrm{n}}$ |  | -0.5 to +5.5 | V |
|  | (Tri-State Mode) $\mathrm{B}_{\mathrm{n}}$ |  | -0.5 to +5.5 | V |
| IIK | DC Input Diode Current | $\mathrm{V}_{1}<$ GND | -20 | mA |
| lok | DC Output Diode Current | $\mathrm{V}_{\mathrm{O}}<\mathrm{GND}^{\text {d }}$ | -50 | mA |
| 10 | DC Output Source/Sink Current |  | $\pm 50$ | mA |
| $\mathrm{I}_{\text {CCA }}$, ICCB | DC Supply Current Per Supply Pin |  | $\pm 100$ | mA |
| IGND | DC Ground Current per Ground Pin |  | $\pm 100$ | mA |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range |  | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{J}$ | Junction Temperature |  | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\theta_{\text {JA }}$ | Junction-to-Ambient Thermal Resistance |  | 53 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\Psi_{\text {JC(top) }}$ | Junction-to-Case (Top) Thermal Resistance |  | 10 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\text {CCA }}, \mathrm{V}_{\text {CCB }}$ | Positive DC Supply Voltage |  | 0.9 | 4.5 | V |
| $V_{1}$ | Bus Input Voltage |  | GND | 4.5 | V |
| $\mathrm{V}_{\mathrm{C}}$ | Control Input | OE | GND | 4.5 | V |
| $\mathrm{V}_{1 \mathrm{O}}$ | Bus Output Voltage (Power Down Mode) | $\mathrm{B}_{\mathrm{n}}$ | GND | 4.5 | V |
|  | (Active Mode) | $\mathrm{B}_{\mathrm{n}}$ | GND | $\mathrm{V}_{\text {CCB }}$ | V |
|  | (Tri-State Mode) | $\mathrm{B}_{\mathrm{n}}$ | GND | 4.5 | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature Range |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta t / \Delta V$ | Input Transition Rise or Rate $V_{1}$, from $30 \%$ to $70 \%$ of $V_{C C} ; V_{C C}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ |  | 0 | 10 | nS |

[^0]DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Test Conditions | $\mathrm{V}_{\text {CCA }}(\mathrm{V})$ | $\mathrm{V}_{\text {CCB }}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  |  | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | $\begin{aligned} & \begin{array}{l} \text { Input HIGH Voltage } \\ \text { (An, OE) } \end{array} \end{aligned}$ |  | 3.6-4.5 | 0.9-4.5 | 2.2 | - | V |
|  |  |  | 2.7-3.6 |  | 2.0 | - |  |
|  |  |  | 2.3-2.7 |  | 1.6 | - |  |
|  |  |  | 1.4-2.3 |  | 0.65 * V ${ }_{\text {CCA }}$ | - |  |
|  |  |  | 0.9-1.4 |  | 0.9 * V ${ }_{\text {CCA }}$ | - |  |
| $\mathrm{V}_{\mathrm{IL}}$ | $\begin{aligned} & \hline \text { Input LOW Voltage } \\ & \text { (An, OE) } \end{aligned}$ |  | 3.6-4.5 | 0.9-4.5 | - | 0.8 | V |
|  |  |  | 2.7-3.6 |  | - | 0.8 |  |
|  |  |  | 2.3-2.7 |  | - | 0.7 |  |
|  |  |  | 1.4-2.3 |  | - | 0.35 * $\mathrm{V}_{\text {CCA }}$ |  |
|  |  |  | 0.9-1.4 |  | - | 0.1 * VCCA |  |
| $\mathrm{V}_{\mathrm{OH}}$ | Output HIGH Voltage | $\mathrm{I}_{\mathrm{OH}}=-100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{1 \mathrm{H}}$ | 0.9-4.5 | 0.9-4.5 | $\mathrm{V}_{\text {CCB }}-0.2$ | - | V |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-0.5 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 0.9 | 0.9 | 0.75 * V CCB | - |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-2 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 1.4 | 1.4 | 1.05 | - |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-6 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 1.65 | 1.65 | 1.25 | - |  |
|  |  |  | 2.3 | 2.3 | 2.0 | - |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 2.3 | 2.3 | 1.8 | - |  |
|  |  |  | 2.7 | 2.7 | 2.2 | - |  |
|  |  | $\mathrm{IOH}=-18 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 2.3 | 2.3 | 1.7 | - |  |
|  |  |  | 3.0 | 3.0 | 2.4 | - |  |
|  |  | $\mathrm{I}_{\mathrm{OH}}=-24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 3.0 | 3.0 | 2.2 | - |  |
| V OL | Output LOW Voltage | $\mathrm{IOL}=100 \mu \mathrm{~A} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {IL }}$ | 0.9-4.5 | 0.9-4.5 | - | 0.2 | V |
|  |  | $\mathrm{I}_{\text {OL }}=0.5 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 1.1 | 1.1 | - | 0.3 |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=2 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ | 1.4 | 1.4 | - | 0.35 |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=6 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ | 1.65 | 1.65 | - | 0.3 |  |
|  |  | $\mathrm{I}_{\mathrm{OL}}=12 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ | 2.3 | 2.3 | - | 0.4 |  |
|  |  |  | 2.7 | 2.7 | - | 0.4 |  |
|  |  | $\mathrm{IOL}=18 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ | 2.3 | 2.3 | - | 0.6 |  |
|  |  |  | 3.0 | 3.0 | - | 0.45 |  |
|  |  | $\mathrm{IOL}=24 \mathrm{~mA} ; \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IL}}$ | 3.0 | 3.0 | - | 0.6 |  |
| 1 | Input Leakage Current | $\mathrm{V}_{1}=\mathrm{V}_{\text {CCA }}$ or GND | 0.9-4.5 | 0.9-4.5 | -1.0 | 1.0 | $\mu \mathrm{A}$ |
| IOFF | Power-Off Leakage Current | $\overline{O E}=0 \mathrm{~V}$ | $\frac{0}{0.9-4.5}$ | $\begin{gathered} 0.9-4.5 \\ 0 \end{gathered}$ | $\begin{aligned} & \hline-1.0 \\ & -1.0 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\mu \mathrm{A}$ |
| $I_{\text {CCA }}$ | Quiescent Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCA}} \text { or GND; } \\ & \mathrm{I}_{\mathrm{O}}=0, \mathrm{~V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}} \end{aligned}$ | 0.9-4.5 | 0.9-4.5 | - | 2.0 | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {CCB }}$ | Quiescent Supply Current | $\begin{aligned} & V_{1}=V_{C C A} \text { or GND; } \\ & l_{0}=0, V_{C C A}=V_{C C B} \end{aligned}$ | 0.9-4.5 | 0.9-4.5 | - | 2.0 | $\mu \mathrm{A}$ |
| $\mathrm{ICCA}+\mathrm{I}_{\text {CCB }}$ | Quiescent Supply Current | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCA}} \text { or GND; } \\ & \mathrm{l}_{\mathrm{O}}=0, \mathrm{~V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}} \end{aligned}$ | 0.9-4.5 | 0.9-4.5 | - | 4.0 | $\mu \mathrm{A}$ |
| $\Delta_{\text {l }}^{\text {CCA }}$ | Increase in ICC per Input Voltage, Other Inputs at $\mathrm{V}_{\text {CCA }}$ or GND | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCA}}-0.6 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCA}} \text { or } \mathrm{GND} \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 3.6 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 3.6 \end{aligned}$ | - | $\begin{aligned} & \hline 10 \\ & 5.0 \end{aligned}$ | $\mu \mathrm{A}$ |
| $\Delta \mathrm{l}_{\text {CCB }}$ | Increase in ICC per Input Voltage, Other Inputs at $\mathrm{V}_{\text {CCA }}$ or GND | $\begin{aligned} & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{CCA}}-0.6 \mathrm{~V} ; \\ & \mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\text {CCA }} \text { or } \mathrm{GND} \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 3.6 \end{aligned}$ | $\begin{aligned} & 4.5 \\ & 3.6 \end{aligned}$ | - | $\begin{aligned} & \hline 10 \\ & 5.0 \end{aligned}$ | $\mu \mathrm{A}$ |
| $\mathrm{I}_{\text {OZ }}$ | I/O Tri-State Output Leakage Current | $\begin{aligned} & \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \overline{\mathrm{OE}}=0 \mathrm{~V}_{\mathrm{CCA}}, \\ & \mathrm{~V}_{\mathrm{O}}=0 \text { to } \mathrm{V}_{\mathrm{CCB}}+0.5 \mathrm{~V} \end{aligned}$ | 0.9-4.5 | 0.9-4.5 | - | 1.0 | $\mu \mathrm{A}$ |
|  |  | $\begin{aligned} & \hline \mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \overline{\mathrm{OE}}=0 \mathrm{~V}_{\mathrm{CCA}}, \\ & \mathrm{~V}_{\mathrm{O}}=0 \text { to } 4.5 \mathrm{~V} \end{aligned}$ |  |  | - | 75 |  |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TOTAL STATIC POWER CONSUMPTION (ICCA $+\mathrm{I}_{\mathrm{CCB}}$ )

| $\mathrm{V}_{\text {cca }}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $\mathrm{V}_{\text {CCB }}(\mathrm{V})$ |  |  |  |  |  |  |  |  |  |  |
|  | 4.5 |  | 3.3 |  | 2.8 |  | 1.8 |  | 0.9 |  |  |
|  | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max |  |
| 4.5 |  | 2 |  | 2 |  | 2 |  | 2 |  | < 1.5 | $\mu \mathrm{A}$ |
| 3.3 |  | 2 |  | 2 |  | 2 |  | 2 |  | < 1.5 | $\mu \mathrm{A}$ |
| 2.8 |  | <2 |  | <1 |  | <1 |  | < 0.5 |  | < 0.5 | $\mu \mathrm{A}$ |
| 1.8 |  | <1 |  | < 1 |  | < 0.5 |  | < 0.5 |  | < 0.5 | $\mu \mathrm{A}$ |
| 0.9 |  | < 0.5 |  | < 0.5 |  | < 0.5 |  | < 0.5 |  | < 0.5 | $\mu \mathrm{A}$ |

NOTE: Connect ground before applying supply voltage $\mathrm{V}_{\mathrm{CCA}}$ or $\mathrm{V}_{\mathrm{CCB}}$. This device is designed with the feature that the power-up sequence of $\mathrm{V}_{\text {CCA }}$ and $\mathrm{V}_{\text {CCB }}$ will not damage the IC.

## AC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | $\mathrm{V}_{\text {CCA }}(\mathrm{V})$ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |  |  |  |  |  |  |  |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\mathrm{V}_{\text {CCB }}(\mathrm{V})$ |  |  |  |  |  |  |  |  |  |  |
|  |  |  | 4.5 |  | 3.3 |  | 2.8 |  | 1.8 |  | 1.5 |  |  |
|  |  |  | Min | Max | Min | Max | Min | Max | Min | Max | Min | Max |  |
| $t_{\text {PLH }}$, $t_{\text {PHL }}$ <br> (Note 1) | Propagation Delay,$A_{n} \text { to } B_{n}$ | 4.5 |  | 3.0 |  | 3.2 |  | 3.4 |  | 3.7 |  | 4.0 | nS |
|  |  | 3.6 |  | 3.3 |  | 3.5 |  | 3.7 |  | 4.0 |  | 4.3 |  |
|  |  | 2.8 |  | 3.5 |  | 3.7 |  | 3.9 |  | 4.2 |  | 4.5 |  |
|  |  | 1.8 |  | 3.8 |  | 4.0 |  | 4.2 |  | 4.5 |  | 4.8 |  |
|  |  | 1.5 |  | 4.1 |  | 4.3 |  | 4.5 |  | 4.8 |  | 5.0 |  |
| $t_{\text {PZH }}$, <br> $t_{\text {PZL }}$ <br> (Note 1) | Output Enable, $\overline{O E}$ to $B_{n}$ | 4.5 |  | 4.4 |  | 4.8 |  | 5.2 |  | 5.7 |  | 6.2 | nS |
|  |  | 3.3 |  | 4.7 |  | 5.1 |  | 5.5 |  | 6.0 |  | 6.5 |  |
|  |  | 2.8 |  | 4.9 |  | 5.3 |  | 5.7 |  | 6.2 |  | 6.7 |  |
|  |  | 1.8 |  | 5.2 |  | 5.6 |  | 6.0 |  | 6.5 |  | 7.0 |  |
|  |  | 1.5 |  | 5.5 |  | 5.9 |  | 6.3 |  | 6.8 |  | 7.3 |  |
| $t_{\text {PHZ }}$, <br> tpLZ <br> (Note 1) | Output Disable, <br> $\overline{O E}$ to $\mathrm{B}_{\mathrm{n}}$ | 4.5 |  | 4.4 |  | 4.8 |  | 5.2 |  | 5.7 |  | 6.2 | nS |
|  |  | 3.3 |  | 4.7 |  | 5.1 |  | 5.5 |  | 6.0 |  | 6.5 |  |
|  |  | 2.8 |  | 4.9 |  | 5.3 |  | 5.7 |  | 6.2 |  | 6.7 |  |
|  |  | 1.8 |  | 5.2 |  | 5.6 |  | 6.0 |  | 6.5 |  | 7.0 |  |
|  |  | 1.5 |  | 5.5 |  | 5.9 |  | 6.3 |  | 6.8 |  | 7.3 |  |
| toshl, <br> tosth <br> (Note 1) | Output to Output Skew, Data to Output | 4.1 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 | nS |
|  |  | 3.6 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  |
|  |  | 2.8 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  |
|  |  | 1.8 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  |
|  |  | 1.2 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  | 0.15 |  |

1. Propagation delays defined per Figures 3 and 4.

CAPACITANCE

| Symbol | Parameter | Test Conditions | Typ (Note 2) | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{IN}}$ | Control Pin Input Capacitance | $\mathrm{V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CCA} / \mathrm{B}}$ | 3.5 | pF |
| $\mathrm{C}_{\mathrm{I} / \mathrm{O}}$ | I/O Pin Input Capacitance | $\mathrm{V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CCA} / \mathrm{B}}$ | 5.0 |  |
| $\mathrm{C}_{\mathrm{PD}}$ | Power Dissipation Capacitance | $\mathrm{V}_{\mathrm{CCA}}=\mathrm{V}_{\mathrm{CCB}}=3.3 \mathrm{~V}, \mathrm{~V}_{\mathrm{I}}=0 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{CCA}}, \mathrm{f}=10 \mathrm{MHz}$ | pF |  |

2. Typical values are at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.
3. $\mathrm{C}_{P D}$ is defined as the value of the IC's equivalent capacitance from which the operating current can be calculated from:
$I_{C C \text { (operating) }} \cong C_{P D} \times V_{C C} \times f_{I N} \times N_{S W}$ where $I_{C C}=I_{C C A}+I_{C C B}$ and $N_{S W}=$ total number of outputs switching.


Figure 3. AC (Propagation Delay) Test Circuit

| Test | Switch |
| :---: | :---: |
| $\mathrm{t}_{\text {PLH }}$, tPHL | OPEN |
| $\mathrm{t}_{\text {PLZ }}$, tPZL | $\mathrm{V}_{\mathrm{CcO}} \times 2$ |
| $t_{\text {PHZ }}$, t ${ }_{\text {PZH }}$ | GND |
| $C_{L}=15 \mathrm{pF}$ or equivalent (includes probe and jig capacitance) <br> $R_{L}=2 \mathrm{k} \Omega$ or equivalent <br> $\mathrm{Z}_{\text {OUT }}$ of pulse generator $=50 \Omega$ |  |



Waveform 1 - Propagation Delays
$t_{R}=t_{F}=2.0 \mathrm{~ns}, 10 \%$ to $90 \% ; f=1 \mathrm{MHz} ; \mathrm{t}_{\mathrm{W}}=500 \mathrm{~ns}$


Waveform 2 - Output Enable and Disable Times
$t_{R}=t_{F}=2.0 \mathrm{~ns}, 10 \%$ to $90 \% ; f=1 \mathrm{MHz} ; \mathrm{t}_{\mathrm{w}}=500 \mathrm{~ns}$
Figure 4. AC (Propagation Delay) Test Circuit Waveforms

| Symbol | $\mathrm{V}_{\mathrm{Cc}}$ |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 3.0 V-4.5 V | 2.3V-2.7V | $1.65 \mathrm{~V}-1.95 \mathrm{~V}$ | 1.4 V-1.6 V | 0.9 V-1.3 V |
| $\mathrm{V}_{\mathrm{mA}}$ | $\mathrm{V}_{\mathrm{CCA}} / 2$ | $\mathrm{V}_{\mathrm{CCA}} / 2$ | $\mathrm{V}_{\mathrm{CCA}} / 2$ | $\mathrm{V}_{\mathrm{CCA}} / 2$ | $\mathrm{V}_{\mathrm{CCA}} / 2$ |
| $\mathrm{V}_{\mathrm{mB}}$ | $\mathrm{V}_{\mathrm{CCB}} / 2$ | $\mathrm{V}_{\mathrm{CCB}} / 2$ | $\mathrm{V}_{\mathrm{CCB}} / 2$ | $\mathrm{V}_{\mathrm{CCB}} / 2$ | $\mathrm{V}_{\mathrm{CCB}} / 2$ |
| $\mathrm{V}_{\mathrm{X}}$ | $\mathrm{V}_{\text {OL }} \times 0.1$ | $\mathrm{V}_{\text {OL }} \times 0.1$ | $\mathrm{V}_{\text {OL }} \times 0.1$ | $\mathrm{V}_{\text {OL }} \times 0.1$ | $\mathrm{V}_{\text {OL }} \times 0.1$ |
| $V_{Y}$ | $\mathrm{V}_{\mathrm{OH}} \times 0.9$ | $\mathrm{V}_{\mathrm{OH}} \times 0.9$ | $\mathrm{V}_{\mathrm{OH}} \times 0.9$ | $\mathrm{V}_{\mathrm{OH}} \times 0.9$ | $\mathrm{V}_{\mathrm{OH}} \times 0.9$ |

L1



DETAIL B OPTIONAL CONSTRUCTION


MOUNTING FOOTPRINT SOLDERMASK DEFINED


NOTES:
. DIMENSIONING AND tolerancing per asme Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINALTIP
4. MOLD FLASH ALLOWED ON TERMINALS ALONG EDGE OF PACKAGE. FLASH 0.03 MAX ON BOTTOM SURFACE OF terminals.
5. DETAIL A SHOWS OPTIONAL CONSTRUCTION FOR TERMINALS.

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 0.45 | 0.55 |
| A1 | 0.00 | 0.05 |
| A3 | 0.127 | REF |
| b | 0.15 | 0.25 |
| D | 1.70 |  |
| BSC |  |  |
| E | 2.00 |  |
| BSC |  |  |
| e | 0.40 |  |
| BSC |  |  |
| K | 0.20 | ---- |
| L | 0.45 | 0.55 |
| L1 | 0.00 | 0.03 |
| L2 | 0.15 |  |
| REF |  |  |

GENERIC
MARKING DIAGRAM*

|  |
| :---: |
|  |

$$
\begin{aligned}
& \text { XX }=\text { Specific Device Code } \\
& \text { M }=\text { Date Code } \\
& \text { - } \quad \text { Pb-Free Package }
\end{aligned}
$$

*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-\mathrm{Free}$ indicator, "G" or microdot " $\mathrm{\bullet}$ ", may or may not be present.

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| DESCRIPTION: | UQFN12 1.7 X 2.0, 0.4P | PAGE 1 OF 1 |

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SOIC-14 NB
CASE 751A-03
ISSUE L
SCALE 1:1


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR

PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE

MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
|  | 1.35 | 1.75 | 0.054 | 0.068 |
| A1 | 0.10 | 0.25 | 0.004 | 0.010 |
| A3 | 0.19 | 0.25 | 0.008 | 0.010 |
| b | 0.35 | 0.49 | 0.014 | 0.019 |
| D | 8.55 | 8.75 | 0.337 | 0.344 |
| E | 3.80 | 4.00 | 0.150 | 0.157 |
| e | 1.27 | BSC | 0.050 | BSC |
| H | 5.80 | 6.20 | 0.228 | 0.244 |
| h | 0.25 | 0.50 | 0.010 | 0.019 |
| L | 0.40 | 1.25 | 0.016 | 0.049 |
| M | $0^{\circ}$ | $7^{\circ}$ | $0^{\circ}$ | $7^{\circ}$ |

## SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS
*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## STYLES ON PAGE 2

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STYLE 1:
PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHODE
4. NO CONNECTION
5. ANODE/CATHODE
6. NO CONNECTION
7. ANODE/CATHODE
8. ANODE/CATHODE
9. ANODE/CATHODE
10. NO CONNECTION
11. ANODE/CATHODE
12. ANODE/CATHODE
13. NO CONNECTION
4. COMMON ANODE
STYLE $5:$

PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHOD
4. ANODE/CATHOD
4. ANODE/CATHODE
5. ANODE/CATHODE
6. NO CONNECTION
7. COMMON ANODE
8. COMMON CATHOD
9. ANODE/CATHODE
10. ANODE/CATHODE
11. ANODE/CATHODE
12. ANODE/CATHODE
13. NO CONNECTION
14. COMMON ANODE

STYLE 2 :
CANCELLED

STYLE 3:
PIN 1. NO CONNECTION 2. ANODE 3. ANODE
4. NO CONNECTION 5. ANODE
6. NO CONNECTION
7. ANODE
8. ANODE
9. ANODE
10. NO CONNECTION
11. ANODE
12. ANODE
13. NO CONNECTION
14. COMMON CATHODE

## STYLE 6

PIN 1. CATHODE
2. CATHODE
3. CATHODE
4. CATHODE
5. CATHODE
5. CATHODE
6. CATHODE
7. CATHOD
8. ANODE
10. ANODE
11. ANODE
12. ANODE
13. ANODE
14. ANODE

STYLE 7:
PIN 1. ANODE/CATHODE
2. COMMON ANODE
3. COMMON CATHODE
4. ANODE/CATHODE
4. ANODE/CATHODE
5. ANODE/CATHODE
6. ANODE/CATHODE
7. ANODE/CATHODE
8. ANODE/CATHODE
9. ANODE/CATHODE
10. ANODE/CATHODE
11. COMMON CATHODE
11. COMMON CATHOD
13. ANODE/CATHODE
14. ANODE/CATHODE

STYLE 4:
PIN 1. NO CONNECTION 2. CATHODE
3. CATHODE
4. NO CONNECTION
5. CATHODE
6. NO CONNECTION
7. CATHODE
. CATHODE
9. CATHODE
10. NO CONNECTION
11. CATHODE
12. CATHODE
13. NO CONNECTION
14. COMMON ANODE

STYLE 8:
PIN 1. COMMON CATHODE
2. ANODE/CATHODE
3. ANODE/CATHODE
4. NO CONNECTION
4. NO CONNECTION
5. ANODE/CATHODE
6. ANODE/CATHODE
7. COMMON ANODE
8. COMMON ANODE
9. ANODE/CATHODE
10. ANODE/CATHODE
11. NO CONNECTION
11. NO CONNECTION
12. ANODE/CATHODE
12. ANODE/CATHODE
13. ANODE/CATHODE
13. ANODE/CATHODE
14. COMMON CATHODE

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NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS MOLD FLASH OR GATE BURRS SHALL NOT MOLD FLASH OR GATE BURRS
4. DIMENSION B DOES NOT INCLUDE

INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 4.90 | 5.10 | 0.193 | 0.200 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 | BSC | 0.026 |  |
| BSC |  |  |  |  |
| H | 0.50 | 0.60 | 0.020 | 0.024 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 | BSC | 0.252 | BSC |
| M | $0{ }^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |

GENERIC MARKING DIAGRAM*



| A | $=$ Assembly Location |
| :--- | :--- |
| L | $=$ Wafer Lot |
| Y | $=$ Year |
| W | $=$ Work Week |
| - | $=$ Pb-Free Package |

(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " $\bullet$ ", may or may not be present.

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| DESCRIPTION: | TSSOP-14 WB | PAGE 1 OF 1 |

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[^0]:    Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

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